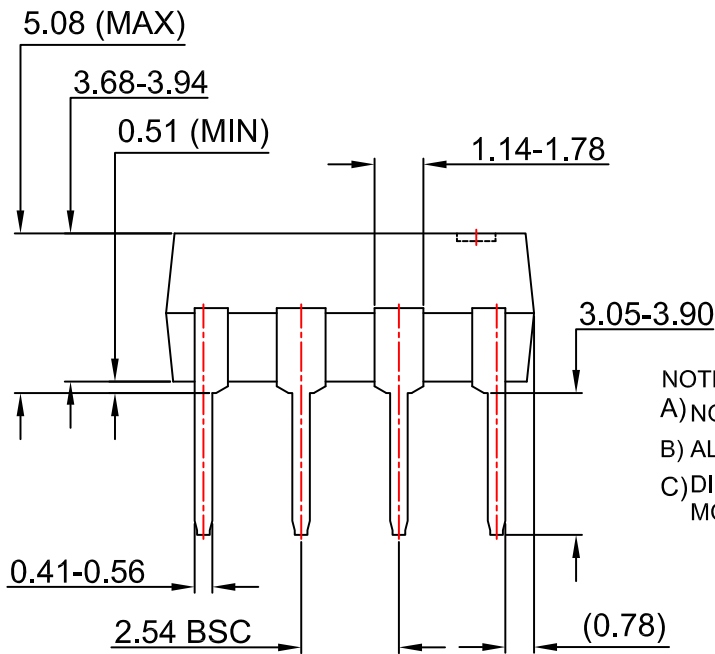
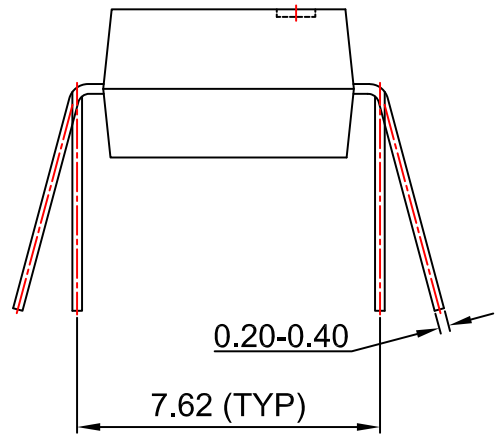
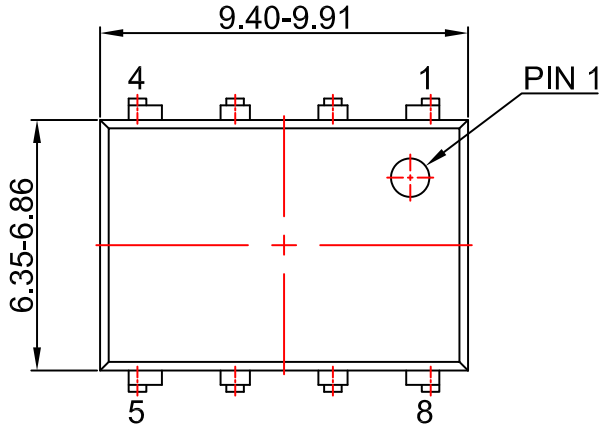


**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

PDIP8 9.655x6.6, 2.54P  
CASE 646CQ  
ISSUE O

DATE 18 SEP 2017



NOTES:  
A) NO STANDARD APPLIES TO THIS PACKAGE  
B) ALL DIMENSIONS ARE IN MILLIMETERS.  
C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

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